

Vishay Siliconix

# N-Channel 150 V (D-S) MOSFET



Marking code: 4848A

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	150					
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 10 \text{ V}$	0.084					
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 4.5 \text{ V}$	0.133					
Q <sub>g</sub> typ. (nC)	4.4					
I <sub>D</sub> (A) <sup>d</sup>	5.5					
Configuration	Single					

#### **FEATURES**

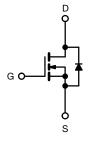
- ThunderFET® power MOSFET
- 100 % R<sub>g</sub> tested
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912



ROHS COMPLIANT HALOGEN FREE

#### **APPLICATIONS**

- DC/DC converters
- · Boost converters
- LED backlighting
- PD switch
- · Load switch



N-Channel MOSFET

ORDERING INFORMATION				
Package	SO-8			
Lead (Pb)-free and halogen-free	Si4848ADY-T1-GE3			

PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V <sub>DS</sub>	150	V
Gate-source voltage		V <sub>GS</sub>	± 20	v
	T <sub>C</sub> = 25 °C		5.5	
O-ation and duals assumed (T. 150 °C)	T <sub>C</sub> = 70 °C		4.4	
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	3.9 <sup>a, b</sup>	
	T <sub>A</sub> = 70 °C		3.1 <sup>a, b</sup>	
Pulsed drain current (t = 100 μs)		I <sub>DM</sub>	20	A
	T <sub>C</sub> = 25 °C		4.2	
Continuous source-drain diode current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	2.1 <sup>a, b</sup>	
Single pulse avalanche current	1 04	I <sub>AS</sub>	10	
Single pulse avalanche energy	L = 0.1 mH	E <sub>AS</sub>	5	mJ
Maximum power dissipation	T <sub>C</sub> = 25 °C		5	
	T <sub>C</sub> = 70 °C		3.2	.,,
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	2.5 <sup>a, b</sup>	W
	T <sub>A</sub> = 70 °C		1.6 <sup>a, b</sup>	
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C

THERMAL RESISTANCE RATINGS							
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT		
Maximum junction-to-ambient a, c	t ≤ 10 s	R <sub>thJA</sub>	43	50	°C/W		
Maximum junction-to-foot (drain)	Steady state	$R_{thJF}$	19	25	C/VV		

#### Notes

- a. Surface mounted on 1" x 1" FR4 board
- b. t = 10 s
- c. Maximum under steady state conditions is 92 °C/W
- d.  $T_C = 25$  °C



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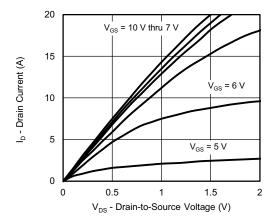
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static				•			
Drain-source breakdown voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	150	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	J 050 A	-	149	-		
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA	-	-7.1	-	mV/°C	
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$	2	-	4	V	
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 150 V, V <sub>GS</sub> = 0 V	-	-	1	μА	
		V <sub>DS</sub> = 150 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 70 °C	-	-	10		
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le 10 \text{ V}, V_{GS} = 10 \text{ V}$	10	-	-	Α	
Due in a course on a data was interest 2	Б	$V_{GS} = 10 \text{ V}, I_D = 3.9 \text{ A}$	-	0.070	0.084	Ω	
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 6 \text{ V}, I_D = 3.1 \text{ A}$	-	0.102	0.133		
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = 10 \text{ V}, I_D = 3.9 \text{ A}$	-	5	-	S	
Dynamic <sup>b</sup>				•			
Input capacitance	C <sub>iss</sub>		-	335	-		
Output capacitance	C <sub>oss</sub>	$V_{DS} = 75 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	70	-	pF	
Reverse transfer capacitance	C <sub>rss</sub>		-	3	-	1	
Total gate charge	Qg	$V_{DS} = 75 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 3.9 \text{ A}$	-	6.5	9.5	9.5 6.6 - nC	
			-	4.4	6.6		
Gate-source charge	Q <sub>gs</sub>	$V_{DS} = 75 \text{ V}, V_{GS} = 6 \text{ V}, I_D = 3.9 \text{ A}$	-	1.5	-		
Gate-drain charge	$Q_{gd}$		-	1.9	-		
Gate resistance	$R_{g}$	f = 1 MHz	0.2	1.1	2.2	Ω	
Turn-on delay time	t <sub>d(on)</sub>		-	8	16		
Rise time	t <sub>r</sub>	$V_{DD} = 75 \text{ V}, \text{ R}_L = 24.2 \Omega, \text{ I}_D \cong 3.1 \text{ A},$	-	22	35	1	
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN}$ = 10 V, $R_g$ = 1 $\Omega$	-	12	24	1	
Fall time	t <sub>f</sub>		-	22	35	1	
Turn-on delay time	t <sub>d(on)</sub>		-	10	20	ns	
Rise time	t <sub>r</sub>	$V_{DD} = 75 \text{ V}, R_L = 24.2 \Omega, I_D \cong 3.1 \text{ A},$	-	22	40	-	
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN}$ = 7.5 V, $R_g$ = 1 $\Omega$	-	10	20		
Fall time	t <sub>f</sub>		-	20	40		
Drain-Source Body Diode Characteristic	cs			•			
Continuous source-drain diode current	Is	T <sub>C</sub> = 25 °C	-	-	2.1		
Pulse diode forward current	I <sub>SM</sub>		-	-	20	A	
Body diode voltage	$V_{SD}$	$I_S = 3.1 \text{ A}, V_{GS} = 0 \text{ V}$	-	0.85	1.2	V	
Body diode reverse recovery time	t <sub>rr</sub>		-	57	86	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>		-	110	165	nC	
Reverse recovery fall time	t <sub>a</sub>	$I_F = 3.1 \text{ A, di/dt} = 100 \text{ A/}\mu\text{s, T}_J = 25 ^{\circ}\text{C}$	-	43	-		
Reverse recovery rise time	t <sub>b</sub>		-	14	_	ns	

#### Notes

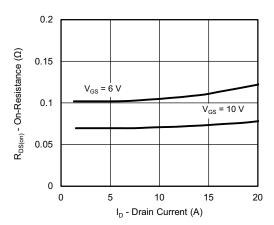
- a. Pulse test; pulse width  $\leq 300~\mu s,\,duty~cycle \leq 2~\%$
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

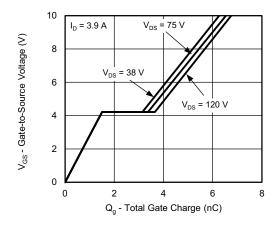




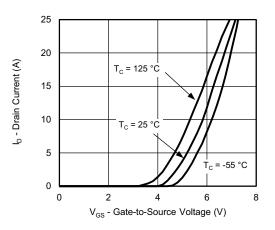
#### **Output Characteristics**



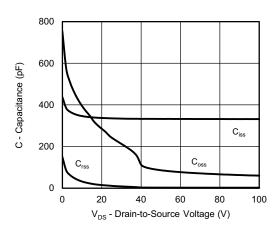
On-Resistance vs. Drain Current and Gate Voltage



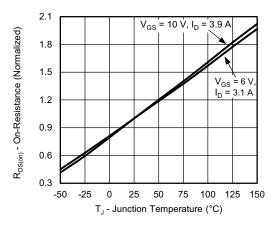
**Gate Charge** 



**Transfer Characteristics** 

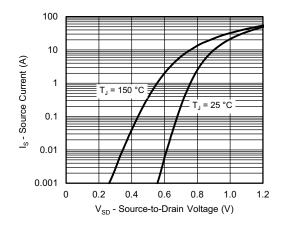


Capacitance

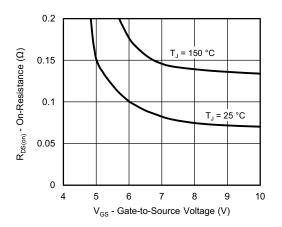


On-Resistance vs. Junction Temperature

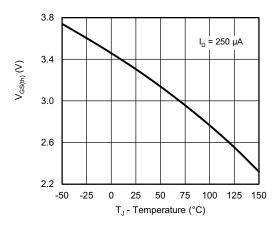




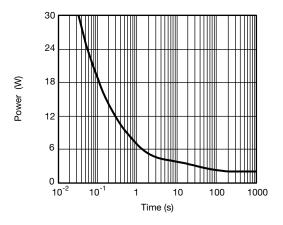
Source-Drain Diode Forward Voltage



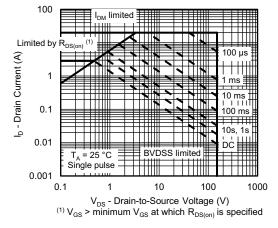
On-Resistance vs. Gate-to-Source Voltage



**Threshold Voltage** 

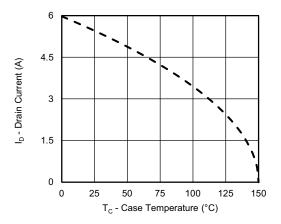


Single Pulse Power, Junction-to-Ambient

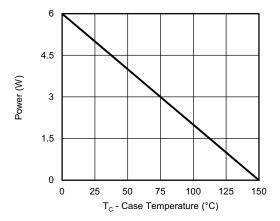


Safe Operating Area, Junction-to-Ambient

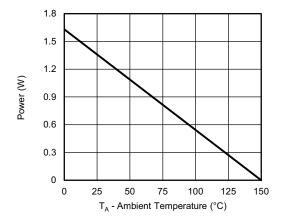




#### Current Derating a





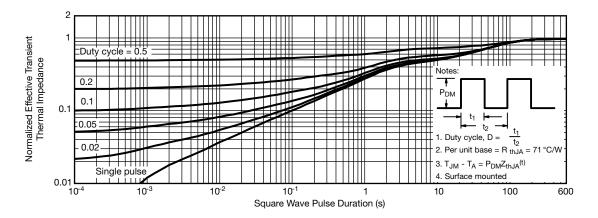


Power, Junction-to-Ambient

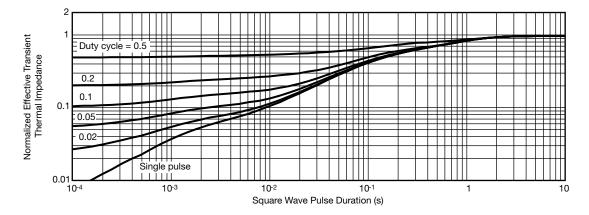
#### Note

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





#### Normalized Thermal Transient Impedance, Junction-to-Ambient



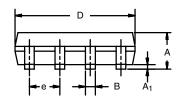
Normalized Thermal Transient Impedance, Junction-to-Case

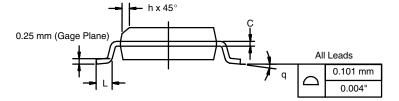
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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	IETERS	INCHES			
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A <sub>1</sub>	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050 BSC			
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I. 11-Sep-06						

DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06

# APPLICATION NOTE



## **RECOMMENDED MINIMUM PADS FOR SO-8**



Recommended Minimum Pads Dimensions in Inches/(mm)

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